

N-Channel Power MOSFET

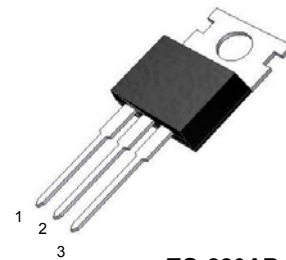
70A, 60V, 0.014Ω

GENERAL DESCRIPTION

This N-Channel MOSFET is used an advanced termination scheme to provide enhanced voltage-blocking capability without degrading performance over time. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance. This device is well suited for high efficiency switched mode power suppliers, active power factor correction, electronic lamp ballasts based half bridge topology.

FEATURES

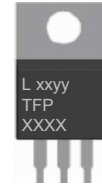
- Avalanche energy specified
- Gate Charge (Typical 70nC)
- High Ruggedness



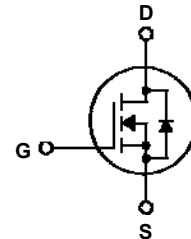
1 = Gate
2 = Drain
3 = Source

TO-220AB

DEVICE MARKING DIAGRAM



L = Tak Cheong Logo
xxyy = Monthly Date Code
TFPXXXX = Device Type



ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise noted)

Symbol	Parameter	Value	Units
V _{DSS}	Drain- Source Voltage	60	V
V _{GSS}	Gate-Source Voltage	± 25	V
I _D	Drain Current	70	A
I _{DM}	Drain Current Pulsed	280	A
P _D	Power Dissipation (Note 2)	158	W
	Derating Factor above 25°C	1.05	W/°C
EAS	Single Pulsed Avalanche Energy (Note 1)	800	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	7.0	V/ns
T _J	Operating Junction Temperature	150	°C
T _{stg}	Storage Temperature Range	- 55 to +150	°C

Notes:

1. L=250uH, I_{AS}=70A, V_{DD}=25V, R_G=0 Ω, Starting T_J=25°C.
2. Repetitive Rating: Pulse width limited by maximum junction temperature.
3. I_{SD} ≤ 70A, di/dt ≤ 300A/us, V_{DD} ≤ BV_{DSS}, Starting T_J=25°C.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
R _{θJC}	Thermal Resistance, Junction-to-Case	0.95	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient	62.5	°C/W

ELECTRICAL CHARACTERISTICS
Off Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	60	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 60V, V_{GS} = 0V$	--	--	1	μA
I_{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 25V, V_{DS} = 0V$	--	--	100	nA
I_{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -25V, V_{DS} = 0V$	--	--	-100	nA

On Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	2.0	--	4.0	V
$R_{DS(ON)}$	On-Resistance	$V_{GS} = 10V, I_D = 35A$	--	--	0.014	Ω

Dynamic Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input Capacitance	$V_{DS} = 25V, V_{GS} = 0V,$ $f = 1.0\text{MHz}$	--	2350	3050	pF
C_{oss}	Output Capacitance		--	690	890	pF
C_{rss}	Reverse Transfer Capacitance		--	160	200	pF

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 30V, I_D = 35A,$ $R_G = 50\Omega$ (Note 4 & 5)	--	30	70	nS
t_r	Turn-On Rise Time		--	60	130	nS
$t_{d(off)}$	Turn-Off Delay Time		--	125	260	nS
t_f	Turn-Off Fall Time		--	95	200	nS
Q_g	Total Gate Charge	$V_{DS} = 48V, I_D = 70A,$	--	70	90	nC
Q_{gs}	Gate-Source Charge	$V_{GS} = 10V$	--	18	--	nC
Q_{gd}	Gate-Drain Charge	(Note 4 & 5)	--	24	--	nC

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Drain-Source Current	Integral Reverse p-n Junction Diode in the MOSFET	--	--	70	A
I_{SM}	Pulsed Drain-Source Current		--	--	280	A
V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0V, I_S = 70A$	--	--	1.5	V
T_{rr}	Reverse Recovery Time	$V_{GS} = 0V, I_S = 70A,$ $dI_F / dt = 100A/\mu S$	--	62	--	nS
Q_{rr}	Reverse Recovery Charge	(Note 4)	--	110	--	μC

Notes:

- Pulse Test: Pulse width < 300 μs , Duty cycle $\leq 2\%$.
- Basically not affected by working temperature.

TYPICAL CHARACTERISTICS

Fig 1. On-State Characteristics

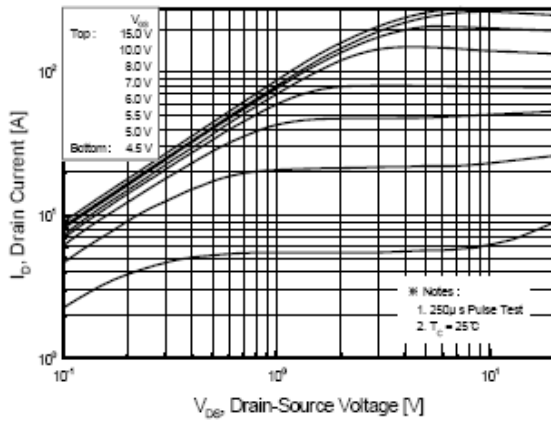


Fig 2. Transfer Characteristics

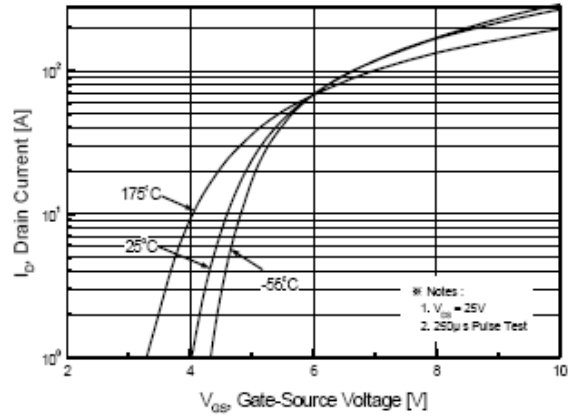


Fig 3. On Resistance Variation vs. Drain Current and Gate Voltage

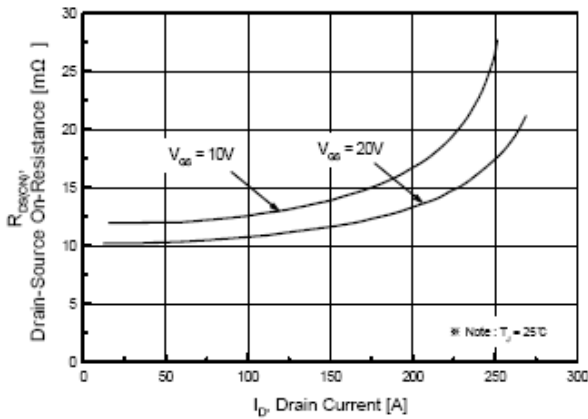


Fig 4. On State Current vs. Allowable Case Temperature

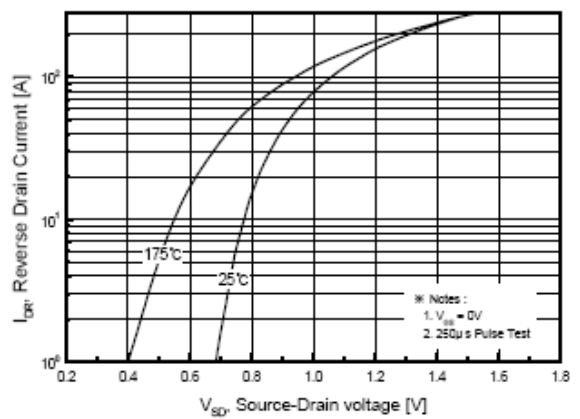


Fig 5. Capacitance Characteristics

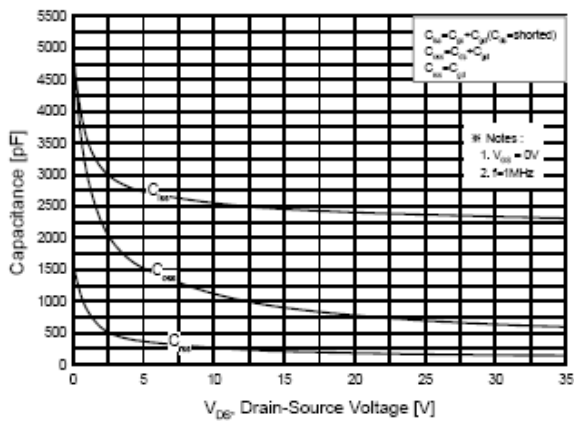


Fig 6. Gate Charge Characteristics

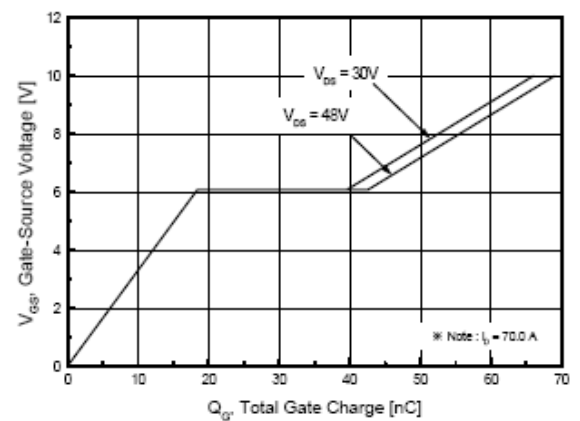


Fig 7. Breakdown Voltage Variation vs. Junction Temperature

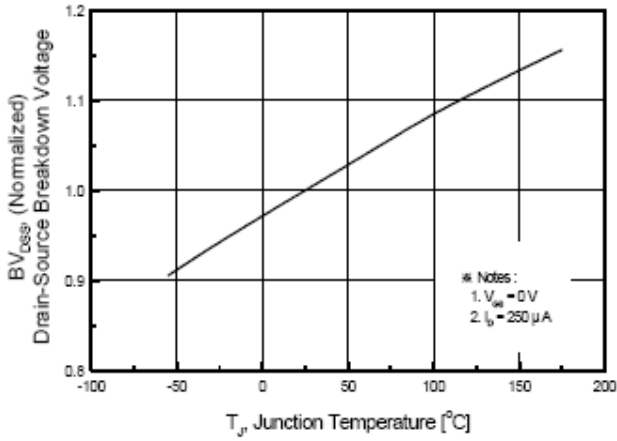


Fig 8. On-Resistance Variation vs. Junction Temperature

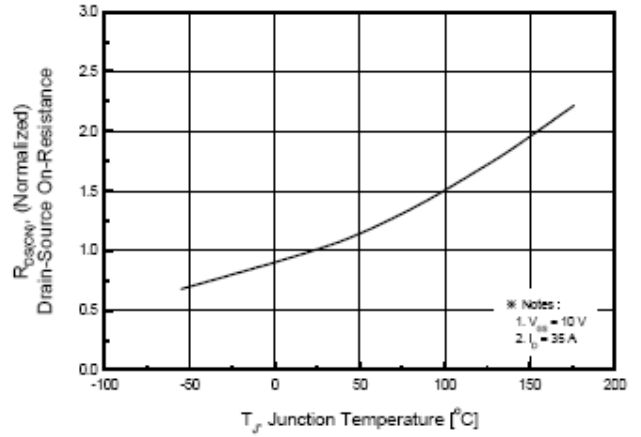


Fig 9. Maximum Safe Operating Area

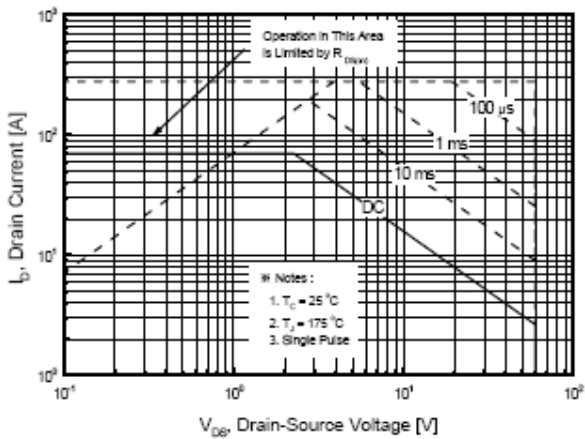


Fig 10. Maximum Drain Current vs. Case Temperature

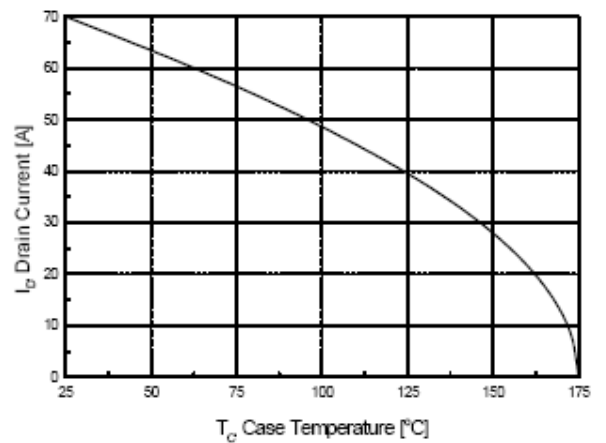


Fig 11. Transient Thermal Response Curve

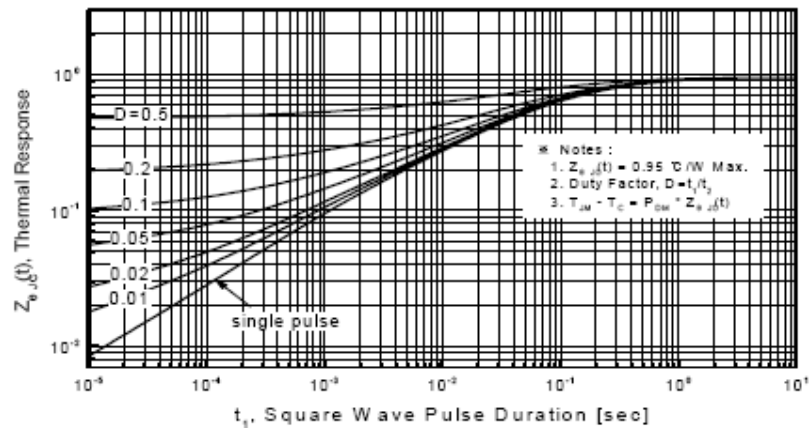


Fig. 12. Gate Charge Test Circuit & Waveforms

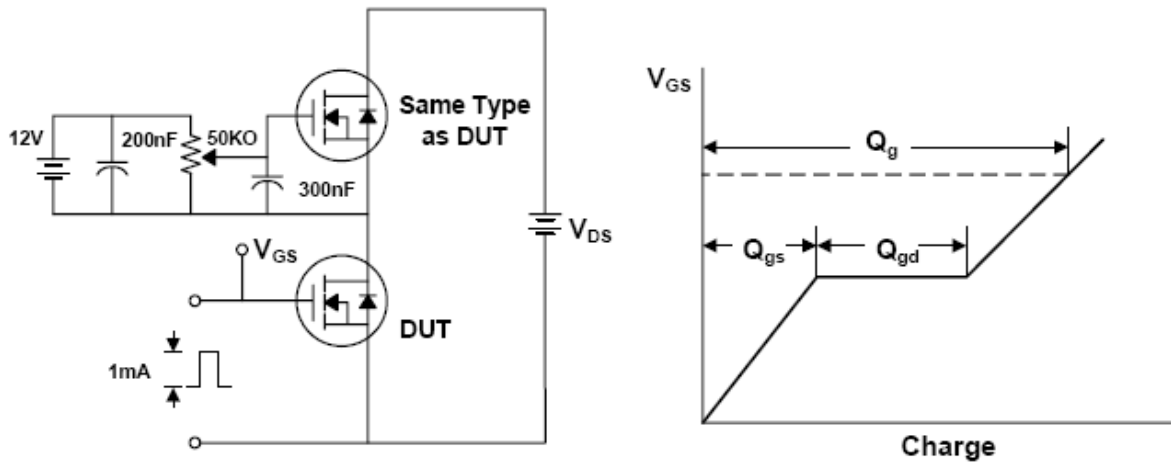


Fig 13. Switching Time Test Circuit & Waveforms

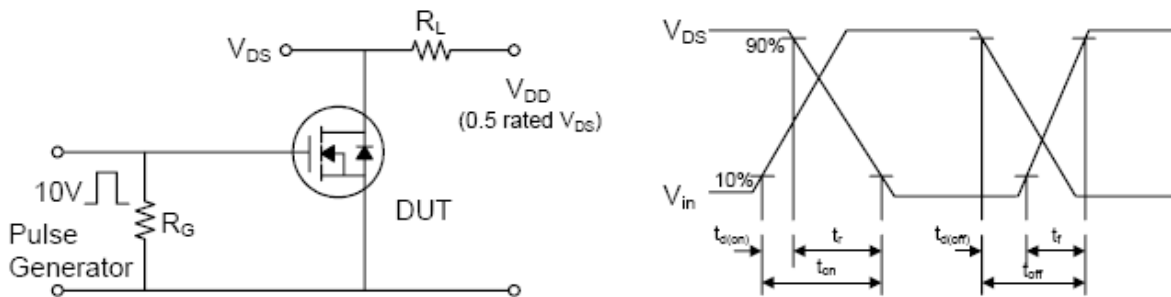


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

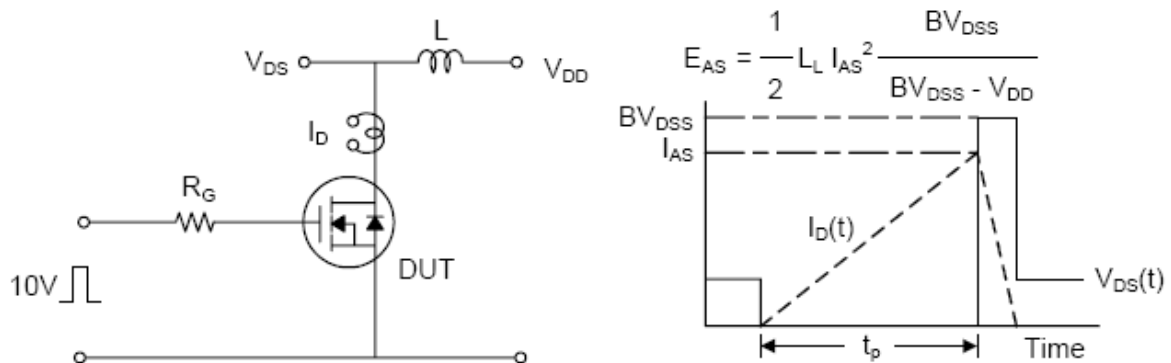
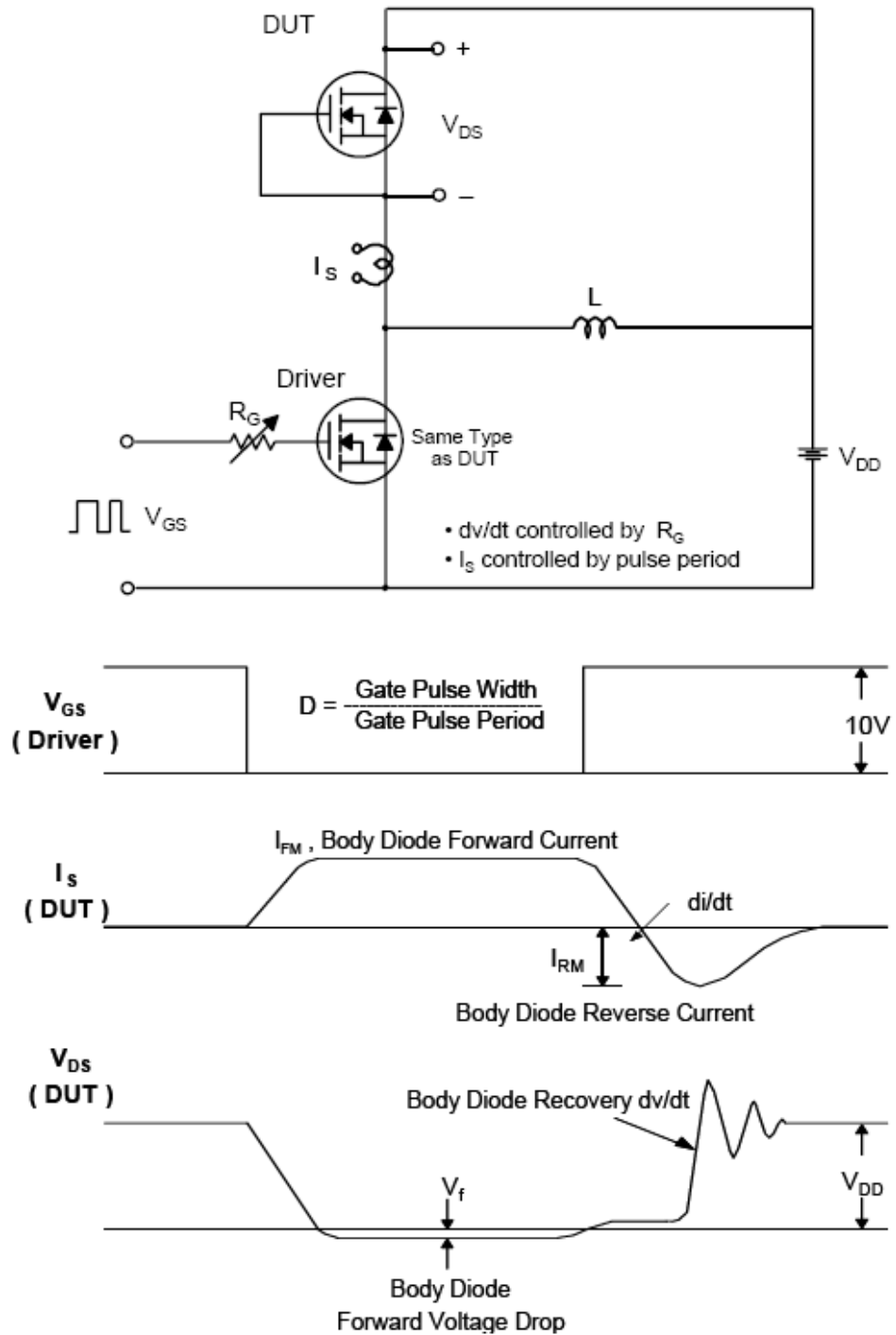
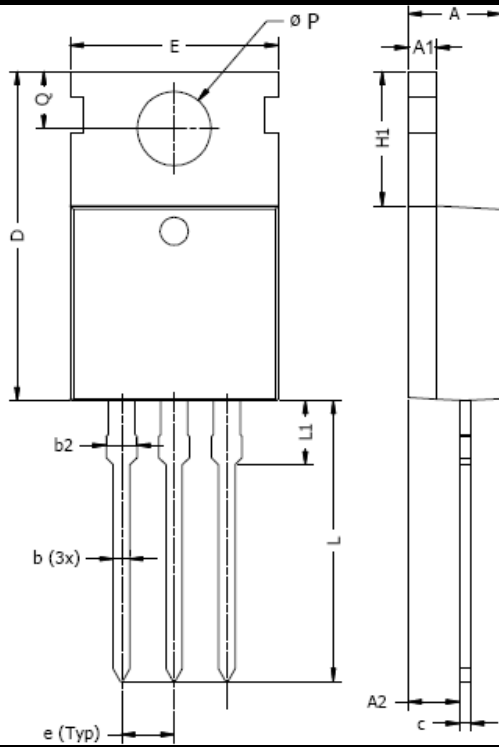


Fig. 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



TO220AB PACKAGE OUTLINE



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	3.60	4.80	0.142	0.189
A1	1.20	1.40	0.047	0.055
A2	2.03	2.90	0.080	0.114
b	0.40	1.00	0.016	0.039
b2	1.20	1.78	0.047	0.070
c	0.36	0.60	0.014	0.024
D	14.22	16.50	0.560	0.650
e	2.34	2.74	0.092	0.108
E	9.70	10.60	0.382	0.417
H1	5.84	6.85	0.230	0.270
L	12.70	14.70	0.500	0.579
L1	2.70	3.30	0.106	0.130
ØP	3.50	4.00	0.138	0.157
Q	2.54	3.40	0.100	0.134

NOTE: Above package outline conforms to JEDEC TO-220AB

NOTICE

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